



# Model : MBA35002 Series

## BGA Heat Sink For 35x35 Chip set

### Specification:

#### 1. Material:

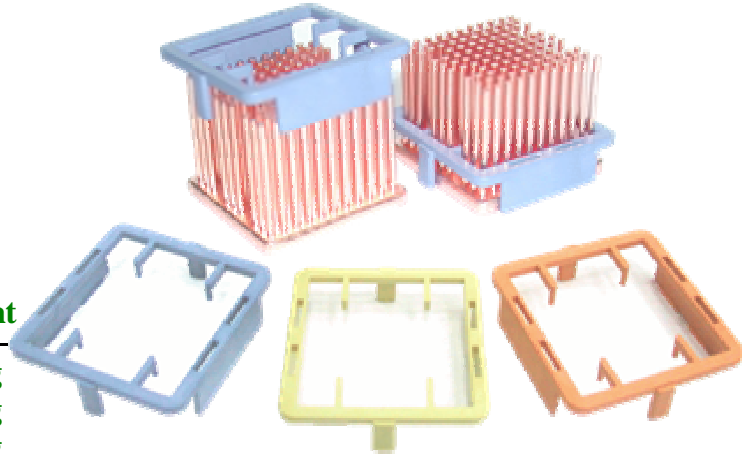
Heat Sink : CU1100

Clip : Plastic (UL94-V0)

#### 2. Heat sink dimension :

Foot print : 35x35mm

Part no.	Height	Fin shape	Base	Clip	Weight
MBA35002-	12	P	/2.6	- Y, BU, O	46.0g
MBA35002-	15	P	/2.6	- Y, BU, O	50.9g
MBA35002-	20	P	/2.6	- Y, BU, O	59.1g
MBA35002-	25	P	/2.6	- Y, BU, O	67.4g



#### 5. Clip available:

Chip set thickness

3.0-3.6mm **Y** -Yellow colored clip

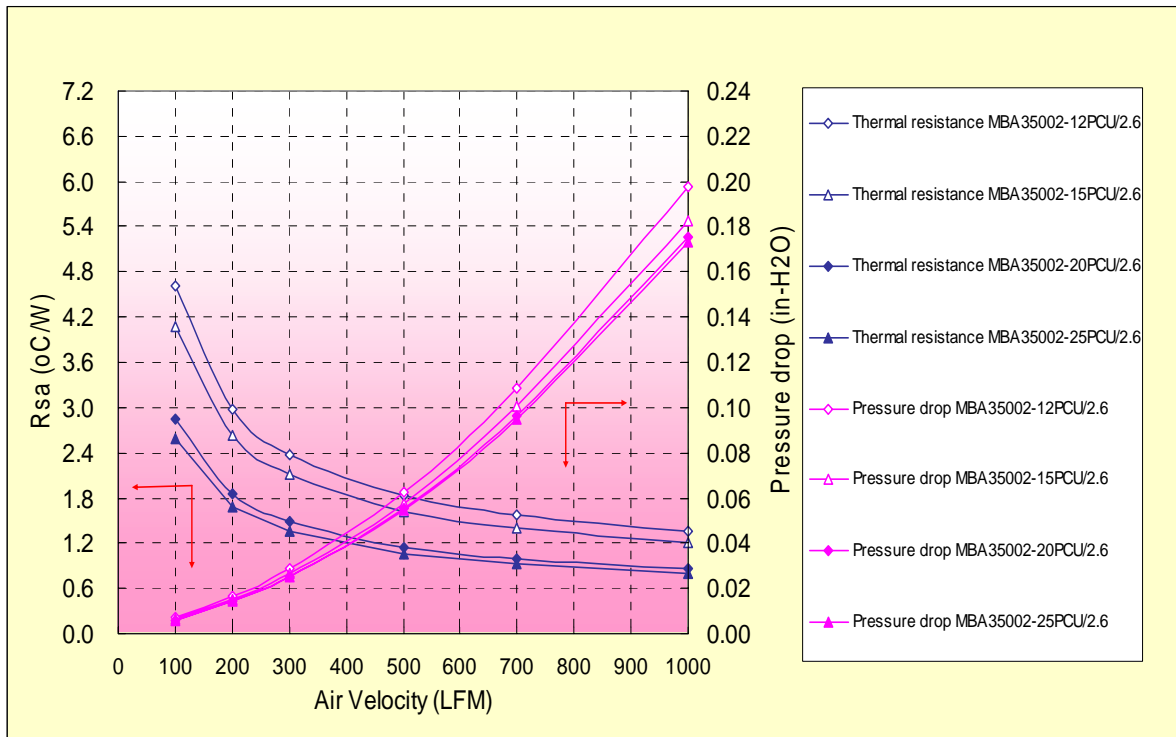
1.4-2.0mm **BU** - Blue colored clip

0.5-1.1mm **O** - Orange colored clip

#### 3. Technology: Precision Forging

#### 4. Finish: Oxygenless Treatment

### Performance Data:



Heat Source Size : Uniform



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